

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## In re Application of:

Salman Akram

Serial No.: 10/797,504

Filed: March 10, 2004

For: METHODS RELATING TO SINGULATING SEMICONDUCTOR WAFERS AND WAFER SCALE ASSEMBLIES (as amended)

Confirmation No.: 3972

Contin mation 110.. 37/2

Group Art Unit: 2823

Examiner: H. Lee

Attorney Docket No.: 2269-5527US

(99-0440.00/US)

Notice of Allowance Mailed:

June 5, 2006

NOTICE OF EXPRESS MAILING

Express Mail Mailing Label Number: EV 826302645 US

Date of Deposit with USPS: August 24, 2006

Person making Deposit: Wendy Neff

OK

p
enter

Lee

9/4/6/6

## AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows: